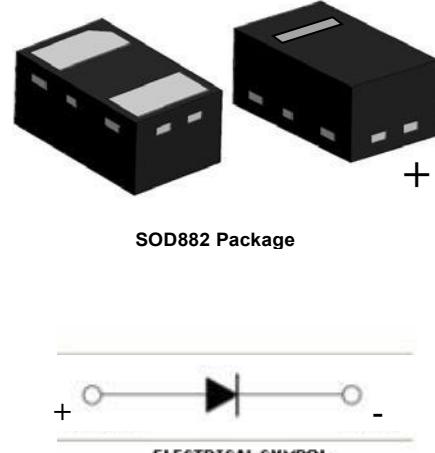


**SE MICONDUCTOR**
**SOD-882 Plastic Package**  
**Schottky Barrier Diode**
**Green Product****Absolute Maximum Ratings**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	150	mW
$T_{STG}$	Storage Temperature Range	-55 to +125	°C
$T_J$	Operating Junction Temperature	+125	°C
$V_R$	DC Reverse Voltage	30	V
$I_{F(AV)}$	Average Forward Current	200	mA
$I_{FSM}$	Peak Forward Surge Current (At 8.3ms single half sine-	0.5	A

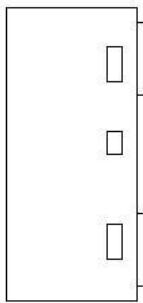
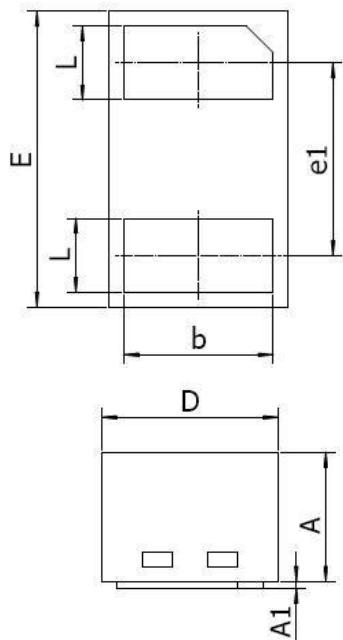
These ratings are limiting values above which the serviceability of the diode may be impaired.

**Specification Features:**

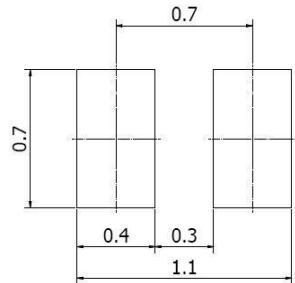
- Low Forward Voltage Drop
- Small Surface Mounting Type (DFN1006)
- RoHS Compliant
- Threan EMC
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode
- Weight: approx. 0.001g

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Condition	Limits		Unit
			Min	Max	
$I_R$	Reverse Leakage Current	$V_R=10\text{V}$		1	$\mu\text{A}$
$V_F$	Forward Voltage	$I_F=10\text{mA}$		0.45	Volts
		$I_F=200\text{mA}$		0.60	Volts

SE MICONDUCTOR**SOD882 Package Outline**

Typical Soldering Pattern(mm):



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.46	0.50	0.018	0.020
A1	---	0.03	---	0.001
b	0.45	0.55	0.018	0.022
D	0.55	0.65	0.022	0.026
E	0.95	1.05	0.037	0.041
e1	Typ. 0.65		Typ. 0.026	
L	0.20	0.30	0.008	0.012